DATA SHEET

SUNGMUN CODE: STP-1152 SERIES

DESCRIPTION : TACT SWITCH

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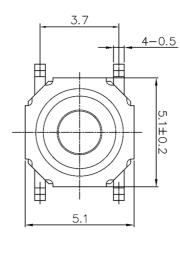
Website www.sungmun.com



P.C.B LAND PATTERN

REVISION

SIGN





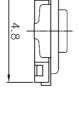


3.7

CIRCUIT DIAGRAM



8.0



6.4±0.2

Ø4.0

SPECIFICATION

1. RATING : DC 12V 50mA

2. TRAVEL: 0.2 ±0.1mm

3. CONTACT RESISTANCE : 100mΩ MAX.

4. BOUNCE: 10m SEC MAX.

200,000 CYCLE	250±50gf	STP-1152S
1,000,000 CYCLE	160±50gf	STP-1152
LIFE CYCLES	OPERATING FORCE	MODEL

	2	1				
_	2019-03-20	T.N JEON	< =	DRAW/DESIGNED	NO.	01
	3-20	<u> </u>	2	SIGNED		1
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	DRAW CTD 11520 C O1	Mm SIZE DRAW CTD 11520 C O1	mm SIZE DRAW CTD 1152X S	UNIT SCALE MODEL STP-1152X SIZE DRAW CTD 11520 C C1	CHECKED APPROVED S.M PARK J.P ROH UNIT SCALE mm SIZE DRAW TACT SWITCH TACT SWITCH SIZE DRAW TO 1.520 C.0.1	DESCRIPTION MATERIAL COLOR/FINISH Q.TY VEND CHECKED APPROVED & G.TOL TITLE TACT SWITCH S.M PARK J.P ROH UNIT SCALE MODEL STP-1152X IN PROPERTY OF THE MODEL STP-1152X BIN ELECTRONICS OF ITE SIZE DRAW CTR 14520 C.O.1



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1. Description:

This specification covers the requirements for single key switches which have no key top(Tact switches mechanical contact).

- 1-1 Operating Temperature Range: -40°C ~ +70°C (normal humidity, normal press)
- 1-2 Test Conditions:

Tests and measurements shall be made in the following standard conditions unless otherwise specified:

Normal temperature (temperature 5 to 35°C)

Normal humidity (relative humidity 45 to 85%)

Normal pressure (pressure 860 to 1,060 mbars)

In case any question arises from the judgment made, tests shall be conducted in the following conditions:

Temperature (20±2°C) Relative humidity (65±5%)

Pressure (860 to 1,060 mbars)

2. Rating:

2-1 Maximum Rating: 50 mA, DC 12V

3. Type of Actuation : PUSH-0N Type

4. Contact Arrangement : 1 poles 1 throws (SPST)



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5. Electrical Characteristics

ITEM	DESCRIPTION	TEST CONDITIONS	REQUIREMENTS
5-1	Visual Examination	By visual examination check without any out pressure & testing.	There shall be no defects that affect the serviceability of the product.
5-2	Contact Resistance	Push force : (Operation force) X 2 Measurements shall be made with a 1kHz small current contact resistance.	100mΩ max.
5-3	Insulation Resistance	D.C 100V for 1 minute. (Between terminals)	100 MΩ min.
5-4	Dielectric withstanding Voltage	A.C 250V for 1 minute. (Between terminals)	There shall be no breakdown
5-5	Bounce	Operation speed : 3~4 time / sec S/W SkΩ Oscillo scope	10ms max.



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6. Mechanical Characteristics

ITEM	DESCRIPTION	TEST CONDITIONS	REQUIREMENTS
6-1	Operating Force	Push by recommended operating condition. Force Push force Return force Stroke	See outside drawing
6-2	Travel	Push by recommended operating condition. F = (Operation force) ×2 F Travel	See outside drawing
6-3	Stop Strength	A static load of 3 kgf shall be applied in the direction of stem operation for a period of 60 seconds.	No damage (Electrical and mechanical)
6-3	Stem Strength	The maximum force to withstand a pull applied opposite to the direction of stem operation shall be measured.	0.5 kgf min
6-5	Operation Life	Measurements shall be made following the test set forth below: 1) 50mA, 12V DC resistive load 2) Rate of operation: 2~3 cycles/ sec 3) Depression: Maximum value of operation force 4) Cycles of operation: See outside drawing	1)As shown in item 5-3, 5-4, 6-2 2)Contact Resistance: 200mΩ max 3)Bounce: 20m sec max 4)Actuating force: ±30% initial force



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7. Environmental Characteristics

ITEM	DESCRIPTION	TEST CONDITIONS	REQUIREMENTS
7-1	Moisture Resistance	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for one hour before measurements. Are made: 1) Temperature: 60±2°C 2) Relative humidity: 90 to 95% 3) Time: 96 hours Water drops shall be removed.	1)As shown in item 5-3, 5-4, 5-5, 6-1, 6-2 2)Contact Resistance: 200mΩ max.
7-2	Resistance Low Temperature	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made: 1)Temperature: -40°C±2°C 2)Time: 96 hours Water drops shall be removed.	1)As shown in item 5-3, 5-4, 5-5, 6-1, 6-2 2)Contact Resistance: 200mΩ max.
7-3	Resistance High Temperature	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made: 1)Temperature: 80°C±2°C 2)Time: 96 hours	1)As shown in item 5-3, 5-4, 5-5, 6-1, 6-2 2)Contact Resistance: 200mΩ max.
7-4	Impact Shock Resistance Measurements shall be made following the test set forth below: 1) Acceleration: 80G 2) Cycles of test: 3 cycles each in 6 directions, for a total of 18 cycles.		Item 5 Item 6-1, 6-2



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ITEM	DESCRIPTION	TEST CONDITIONS	REQUIREMENTS
7-5	Change of Temperature	Following ten cycles of high temperature test. The sample shall be placed in normal temperature and humidity conditions for one hour before measurements are made. During this test, water drops shall be removed. 60°C 2h 1h 2h 1h Cycling: 5 cycle	1)As shown in item 5-3, 5-4, 5-5, 6-1, 6-2 2)Contact Resistance: 200mΩ max.
7-6	Salt mist Test	Switch shall be checked after following test. 1) Salt solution: 5±1% 2) Temperature: 35±2°C 3) Time: 48 hours	Without excessive rust or discoloration
7-7	Vibration Resistance	Measurements shall be made following the test set forth below: 1) Range of oscillation: 10 to 55Hz 2) Amplitude, peak to peak: 1.5mm 3) Cycle of sweep: 10-55-10Hz in a minute. 4) Mode of sweep: Logarithmically seep or uniform sweep. 5) Direction of oscillation: Three mutually perpendicular direction, including the direction of stem travel. 6) 2 hours each for a total of 6 hours.	Item 5 Item 6-1, 6-2
7-8	Soldering Test	Soldering area: t/2 of P.W.B thickness (P.W.B: t = 1.6) Soldering temperature: 260±5°C Soldering time: 5±1 sec	No damage (Electrical and mechanical)

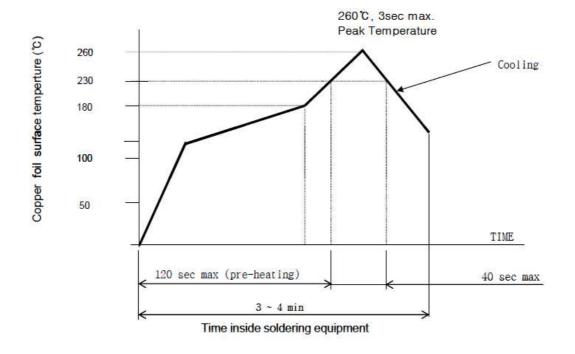


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- 8. This item is "RoHS" Compliant
- 9. Reflow Soldering Conditions:
 - 9-1 Preheat: Temperature on the copper foil surface should reach 180°C, 2±0.3 minutes after the P.W.B entered into the soldering equipment.
 - 9-2 Soldering heat: Temperature on the copper foil surface should reach the peak temperature of 260°C within 40 seconds after the P.W.B entered into soldering heat zone.



Temperature Profile